

Low Loss Current Limited Load Switch

General Description

The WP25101T5-B is current limited P-channel MOSFET power switch designed for high-side load switching applications. This switch operates with inputs ranging from 2.5V to 5.5V, making it ideal for both 3.3V and 5V systems. An integrated current-limiting circuit protects the input supply against large currents which may cause the supply to fall out of regulation. The WP25101T5-B is also protected from thermal overload which limits power dissipation and junction temperatures. It can be used to control load that requires 1A. The quiescent supply current in active mode is only 28 μ A. In shutdown mode, the supply current decreases to less than 1 μ A. Fault flag ($\overline{\text{FLT}}$) can indicate over current and fault conditions.

The WP25101T5-B is available in Pb-free packages and is specified over the -40°C to +85°C ambient temperature range.

Features

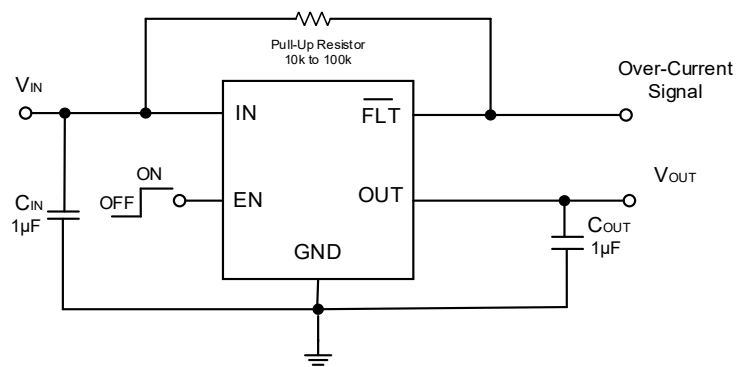
- Input Voltage Range: 2.5V to 5.5V
- 1.5A Accurate Current Limit
- Reverse Current Blocking
- Short-Circuit Response: 2 μ s
- Very Low Quiescent Current: 28 μ A (Typ)

- 1 μ A Max Shutdown Supply Current
- Fault Flag ($\overline{\text{FLT}}$) output for over current and fault conditions.
- Built-in Pull-up Resistor for EN Pin
- Automatic Output Discharge at Shutdown
- Under-Voltage Lockout
- Thermal Shutdown
- 2kV ESD Rating
- Package: SOT23-5
- Ambient Temperature Range: -40°C to +85°C

Applications

- Laptop/Desktop Computers and Netbooks
- 3G Wireless Cards
- Smart Phones and PDAs
- LCD TVs and Monitors
- Set-Top-Boxes
- MP3/MP4
- Printers
- Portable Game Players
- Portable Media Players and MIDs
- USB Keyboards
- USB Hard Disk Drives
- USB Memory Drives
- USB Hubs

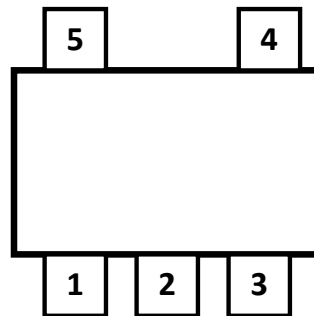
Typical Application



Note: Tantalum or Aluminum Electrolytic capacitors (C_{IN} and C_{OUT}) may be required for USB applications

Pin Configuration

(Top View)



SOT23-5

Pin Description

| Pin Number | Pin Name | Pin Function |
|------------|-------------------------|----------------------------|
| 1 | OUT | Power output. |
| 2 | GND | Ground pin. |
| 3 | $\overline{\text{FLT}}$ | Open drain fault flag |
| 4 | EN | Enable input, High enable. |
| 5 | IN | Power supply input. |

Absolute Maximum Ratings

| Parameter | Rating | Unit |
|--|-------------------------------|-----------------------------|
| IN, EN, $\overline{\text{FLT}}$ Voltage | -0.3 to 6 | V |
| OUT Voltage | -0.3 to $V_{\text{IN}} + 0.3$ | V |
| OUT Current | Internal Limited | A |
| Power Dissipation | 400 | mW |
| Package Thermal Resistance(θ_{JA}) | 250 | $^{\circ}\text{C}/\text{W}$ |
| Operating Junction Temperature | -40 to 125 | $^{\circ}\text{C}$ |
| Storage Temperature | -55 to 150 | $^{\circ}\text{C}$ |
| Lead Temperature (Soldering, 10 sec) | 300 | $^{\circ}\text{C}$ |

Electrical Characteristics

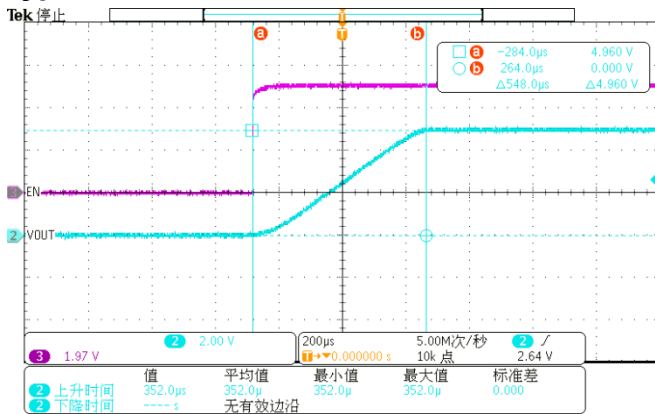
 ($V_{IN}=+5.0V$, $T_A=25^{\circ}C$, unless otherwise specified.)

| Symbol | Parameter | Test Conditions | Min | Typ. | Max | Unit |
|-----------------------------|------------------------------------|--|-----|-------|-----|-------------|
| V_{IN} | Input Voltage Range | | 2.5 | | 5.5 | V |
| I_{SHDN} | Shutdown Quiescent Current | Disabled, OUT floating or shorted to ground | | 0.3 | 1 | μA |
| I_Q | Quiescent Current | Enabled, $I_{OUT}=0$ | | 28 | 60 | μA |
| $R_{DS(ON)}$ | Switch on-resistance | $V_{IN}=5V$, $I_{OUT}=0.6A$ | | 70 | 120 | m Ω |
| I_{LMT} | Current Limit | $V_{IN}=5V$, $V_{OUT}=4.5V$ | 1.2 | 1.5 | 1.8 | A |
| V_{IL} | EN Input Logic Low Voltage | Note 1 | | | 0.5 | V |
| V_{IH} | EN Input Logic High Voltage | Note 1 | 1.5 | | | V |
| $R_{\overline{FLT}}$ | \overline{FLT} Low Resistance | Note 2 | | 250 | | Ω |
| $T_{\overline{FLT_Delay}}$ | \overline{FLT} Delay Time | Note 2 | | 15 | | ms |
| I_{SINK} | EN Input leakage | $V_{EN}=5V$ | | 0.01 | 1 | μA |
| | | $V_{EN}=0V$ | -2 | -0.25 | | μA |
| V_{UVLO} | Input UVLO Threshold | | 1.4 | 1.8 | 2.2 | V |
| $V_{UVLOHys}$ | Input UVLO Hysteresis | | | 0.1 | | V |
| I_{REV} | Reverse Leakage Current | $V_{IN}=0V$, $V_{OUT}=5V$, I_{REV} at V_{IN} | | 0.1 | 1 | μA |
| T_{ON} | Output Turn-on Delay Time | $V_{IN}=5V$, $C_L=1\mu F$, $R_{LOAD}=100\Omega$ | 0.2 | 0.5 | 1 | ms |
| T_R | Output Turn-on Rise Time | $V_{IN}=5V$, $C_L=1\mu F$, $R_{LOAD}=100\Omega$ | 0.2 | 0.4 | 0.8 | ms |
| T_{OFF} | Output Turn-off Delay Time | $V_{IN}=5V$, $C_L=1\mu F$, $R_{LOAD}=100\Omega$ | 0.2 | 0.5 | 0.8 | ms |
| T_F | Output Turn-off Fall Time | $V_{IN}=5V$, $C_L=1\mu F$, $R_{LOAD}=100\Omega$ | 100 | 300 | 450 | μs |
| $R_{dischrg}$ | Output discharge FET $R_{DS(ON)}$ | Disabled, $V_{IN}=5V$, $V_{OUT}=1V$ | 50 | 200 | 350 | Ω |
| T_{SHDN} | Thermal shutdown threshold | $V_{IN}=5V$ | | 150 | | $^{\circ}C$ |
| T_{HYS} | Thermal shutdown hysteresis | $V_{IN}=5V$ | | 20 | | $^{\circ}C$ |
| ESD HBM | Human Body Model ESD Protection | | | 2000 | | V |

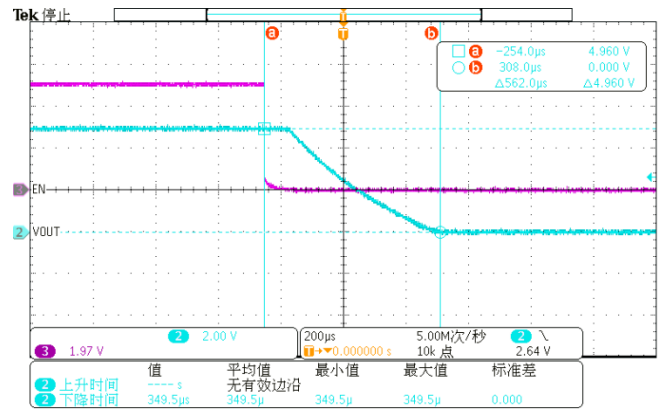
Note 1: When EN pin is floating, the chip is enabled.

Note 2: Guaranteed by design

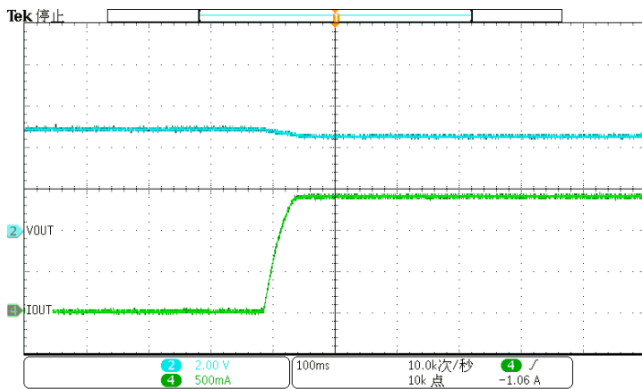
Typical Performance Characteristics



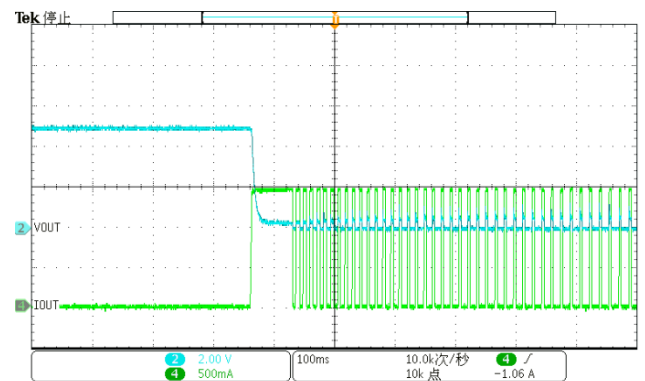
Turn On Response



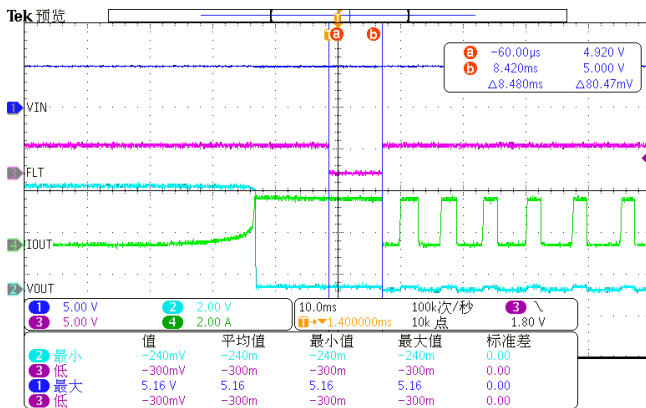
Turn Off Response



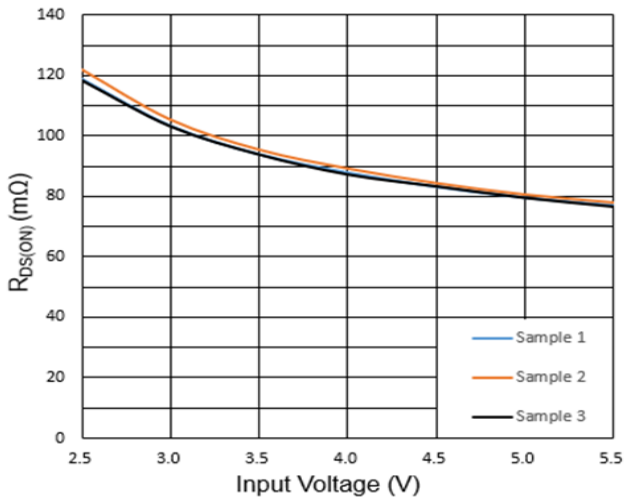
Over Current-Limit



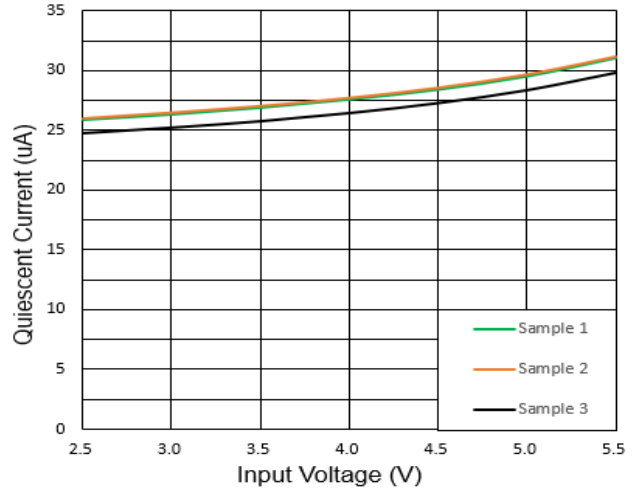
Short Current Response & Thermal Shutdown



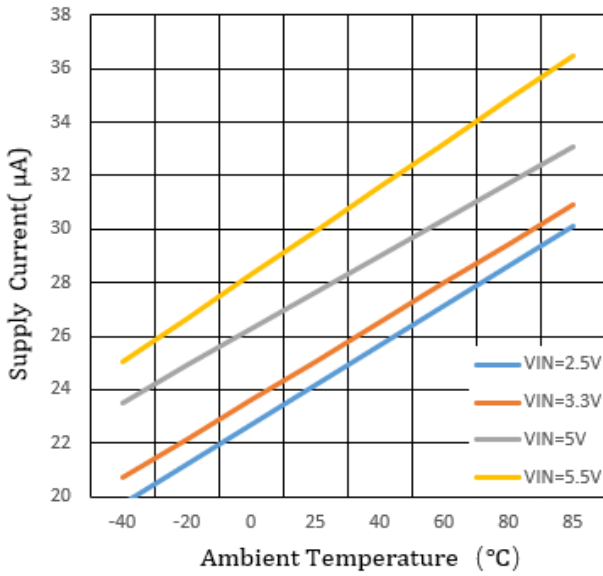
Over Current Conditions Indicated by \overline{FLT}



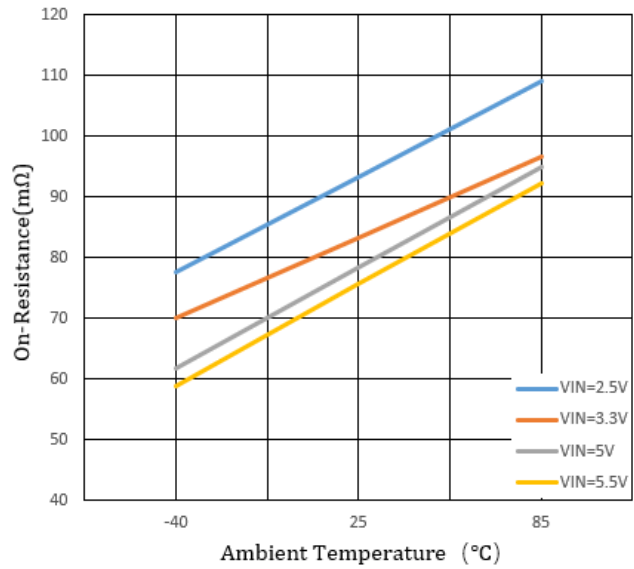
R_{DS(ON)} (mΩ) vs. Supply Voltage



Quiescent Current vs. Supply Voltage

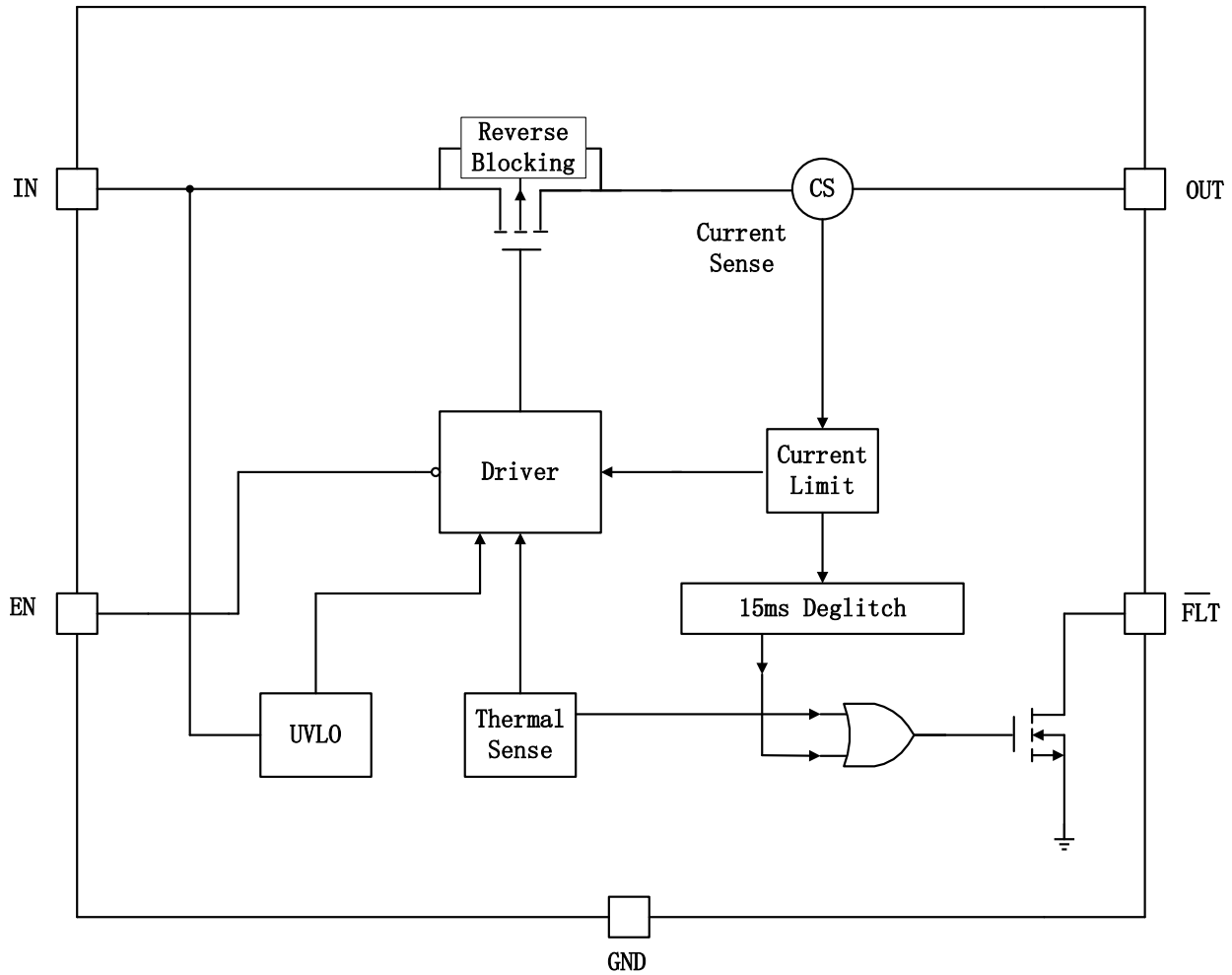


Quiescent Supply Current vs. Ambient Temperature



Switch On-Resistance vs. Ambient Temperature

Block Diagram



Operation

WP25101T5-B is an integrated power switch with a low $R_{DS(ON)}$ P-channel MOSFET, internal gate drive circuit. When the WP25101T5-B turns on, it can deliver up to 1A continuous current to load. When the device is active, if there is no load, the device only consumes 28 μ A supply current, which makes the device suitable for battery powered applications.

Power Supply Considerations

A 0.1 μ F to 1 μ F ceramic bypass capacitor between IN and GND, close to the device, is recommended. Placing a high-value electrolytic capacitor on the output pin is recommended when the output load is heavy. This precaution reduces power-supply transients that may cause ringing on the input and minimize the input voltage droops. Additionally, bypassing the output with a 0.1 μ F to 1 μ F ceramic capacitor improves the immunity of the device to short-circuit transients.

Power Dissipation and Junction Temperature

The low on-resistance on the P-channel MOSFET allows the small surface-mount packages to pass large currents. It is good design practice to check power dissipation and junction temperature for each application. Begin by determining the $R_{DS(ON)}$ of the P-channel MOSFET relative to the input voltage and operating temperature. Using the highest operating ambient temperature of interest and $R_{DS(ON)}$, the power dissipation per switch can be calculated by:

$$P_D = R_{DS(ON)} \times I^2$$

Finally, calculate the junction temperature:

$$T_J = P_D \times R_{\theta JA} + T_A$$

Where:

T_A = Ambient temperature

$R_{\theta JA}$ = Thermal resistance

P_D = Total power dissipation

Compare the calculated junction temperature with the maximum junction temperature which is 125°C. If they are within degrees, either the maximum load current needs to be reduced or another package option will be required.

Over Current

A sense FET is employed to check for over current conditions. When an over current condition is detected, the device maintains a constant output current and reduces the output voltage accordingly. WP25101T5-B will limit the current until the overload condition is removed or the device begins to thermal cycle.

Three possible overload conditions can occur. In the first condition, the output has been shorted before the device is enabled or before V_{IN} has been applied. The WP25101T5-B senses the short and immediately switches into a constant-current output.

In the second condition, a short or an overload occurs while the device is enabled. At the instant the overload occurs, high currents may flow for a short period of time before the current-limit circuit can react. After the current-limit circuit reached the overcurrent trip threshold, the device switches into constant-current mode.

In the third condition, the load has been gradually increased beyond the recommended operating current. The current is permitted to rise until the current-limit threshold is reached or until the thermal limit of the device is exceeded. The WP25101T5-B is capable of delivering current up to the current-limit threshold without damaging the device. Once the threshold has been reached, the device switches into its constant-current mode.

Thermal Protection

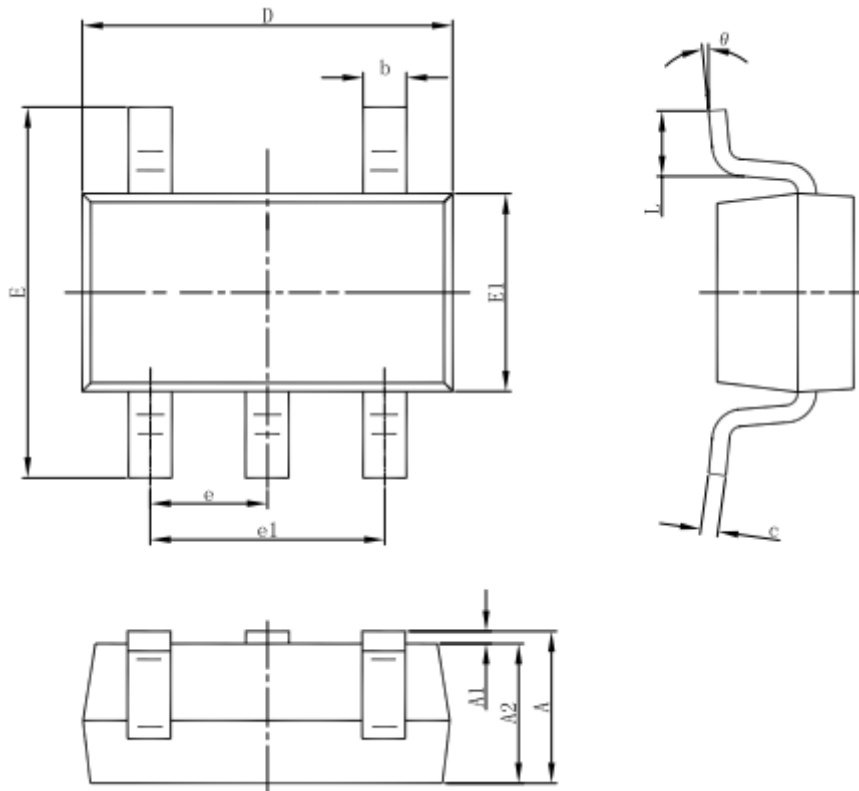
Thermal protection prevents damage to the IC when overload or short-circuit faults are present for extended periods of time. The WP25101T5-B implements a thermal sensing to monitor the operating junction temperature of the power distribution switch. In an over current or short-circuit condition, the junction temperature rises due to excessive power dissipation. Once the die temperature rises to approximately 150°C due to over current conditions, the internal thermal sense circuitry turns the power switch off, thus preventing the power switch from damage. Hysteresis is built into the thermal sense circuit, and after the device has

WP25101T5-B

cooled approximately 20° C, the switch turns back on. The switch continues to cycle in this manner until the load fault or input power is removed.

Fault Flag ($\overline{\text{FLT}}$)

The Fault flag ($\overline{\text{FLT}}$) can indicate over current condition. Fault flag is an open drain signal and must be pulled up by a pull-up resistor. Fault flag is logic high in normal. When over current occurs, fault flag change to logic low with a duration of at least 8 ms after about 15ms delay which is guaranteed by design. Therefore fault flag is a negative pulse signal, not a level signal. A heavy load may cause a momentary over current condition, however, no false reporting occurs on $\overline{\text{FLT}}$ due to the 15ms deglitch circuits.

Package Information

SOT23-5

| SYMBOL | DIMENSIONS IN MILLIMETERS | |
|-----------|---------------------------|-------|
| | MIN | MAX |
| A | 1.000 | 1.350 |
| A1 | 0.000 | 0.150 |
| A2 | 1.000 | 1.200 |
| b | 0.300 | 0.500 |
| c | 0.100 | 0.200 |
| D | 2.820 | 3.020 |
| E1 | 1.500 | 1.700 |
| E | 2.600 | 3.000 |
| e | 0.950(BSC) | |
| e1 | 1.800 | 2.000 |
| L | 0.300 | 0.600 |
| θ | 0° | 8° |

WP25101T5-B



Ordering Information

| Part Number | Current Limit | Package | Packing Quantity | Marking* |
|-------------|---------------|---------|------------------|-------------|
| WP25101T5-B | 1.5A | SOT23-5 | 3k/Reel | 25101 BXXXX |

*XXXX is variable.


Contact Information

No.1001, Shiwan(7) Road, Pudong District, Shanghai, P.R.China.201202

Tel: 86-21-68960674 Fax: 86-21-50757680 Email: market@way-on.com

WAYON website: <http://www.way-on.com>

For additional information, please contact your local Sales Representative.

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Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.

Users should verify actual device performance in their specific applications.

单击下面可查看定价，库存，交付和生命周期等信息

[>>WAY-ON\(维安\)](#)